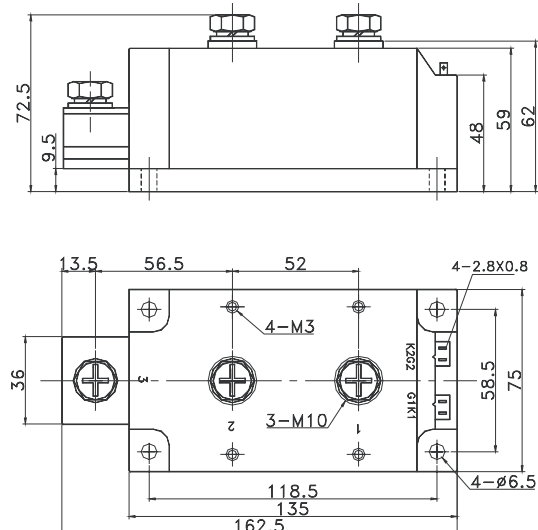
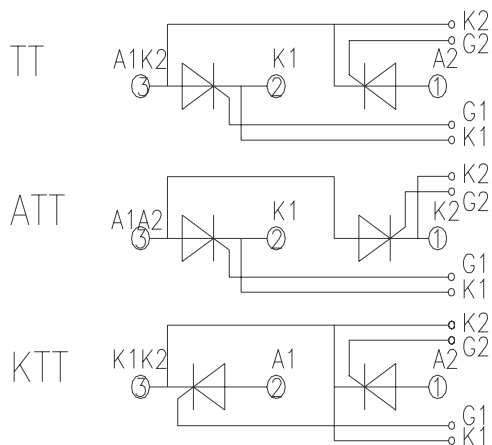


TT400 ATT400 KTT400

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _J (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _C =85°C	125			400	A
I _{T(RMS)}	RMS on-state current	as AC switch				840	A
V _{DRM} V _{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	V _{DRM} &V _{RRM} tp=10ms V _{DSM} &V _{RSM} = V _{DRM} &V _{RRM} +200V respectively	125	600		1800	V
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			40	mA
I _{TSM}	Surge on-state current	10ms half sine wave	125			12.0	KA
I ² t	I ² T for fusing coordination	V _R =60%V _{RRM}				734	A ² s*10 ³
V _{TO}	Threshold voltage	125				0.80	V
r _T	On-state slop resistance					0.49	m
V _{TM}	Peak on-state voltage	I _{TM} =1200A 125				1.52	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM} 125				800	V/ s
di/dt	Critical rate of rise of on-state current	From 67%V _{DRM} to 1200A, Gate source 1.5A t _r "0.5 s Repetitive	125			100	A/ s
I _{GT}	Gate trigger current	V _A =12V, I _A =1A 25		30		200	mA
V _{GT}	Gate trigger voltage			1.0		3.0	V
I _H	Holding current			20		100	mA
V _{GD}	Non-trigger gate voltage	At 67%V _{DRM} 125				0.2	V
R _{th(j-c)}	Thermal resistance Junction to heatsink	At 180° sine Single side cooled				0.080	°C /W
V _{iso}	Isolation voltage	50Hz,R.M.S,t=1min,I _{iso} :1mA(MAX)		2500			V
F _m	Thermal connection torque(M10)				0.60		Nm
	Mounting torque(M6)				0.30		Nm
T _{stg}	Stored temperature			-40		140	°C
W _t	Weight				2300		g
Outline	408F3						

OUTLINE DRAWING & CIRCUIT DIAGRAM



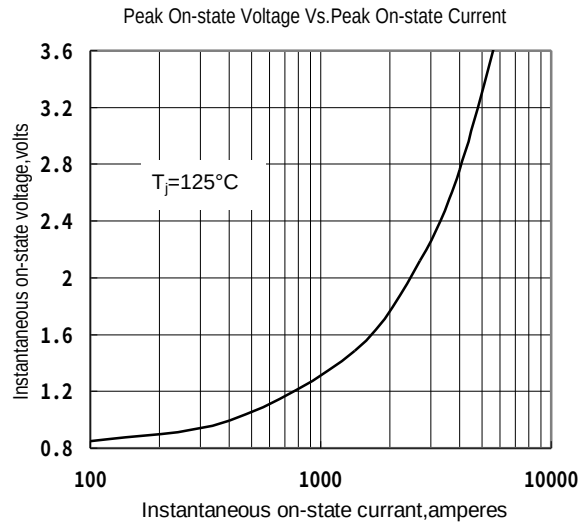


Fig.1

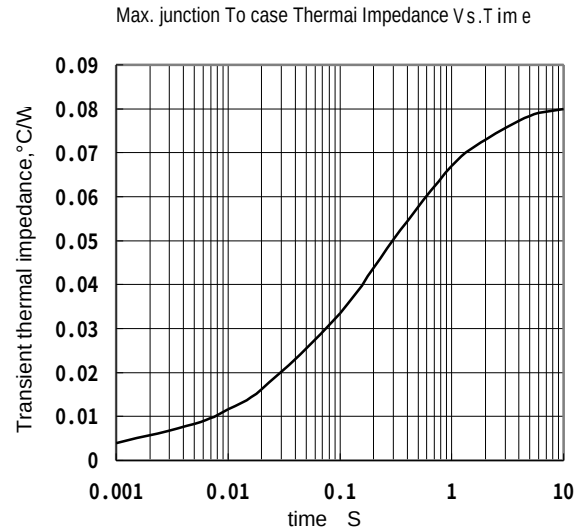


Fig.2

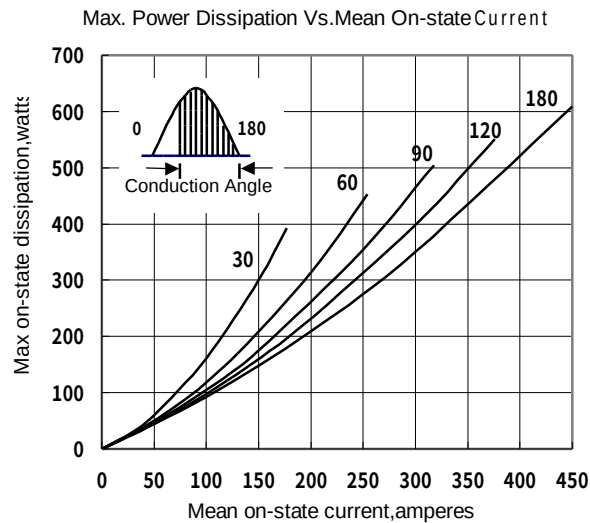


Fig.3

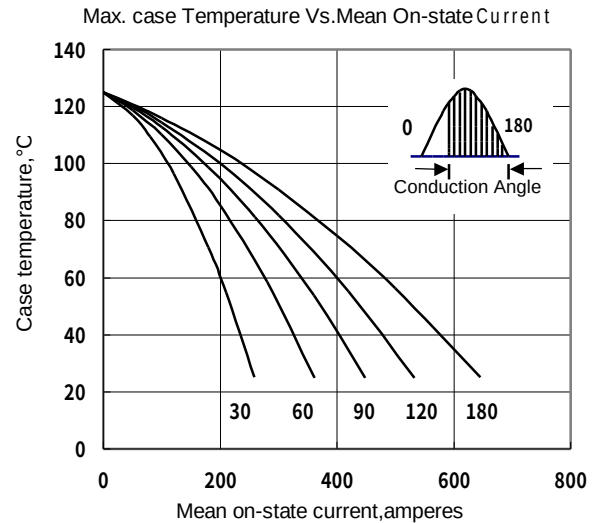


Fig.4

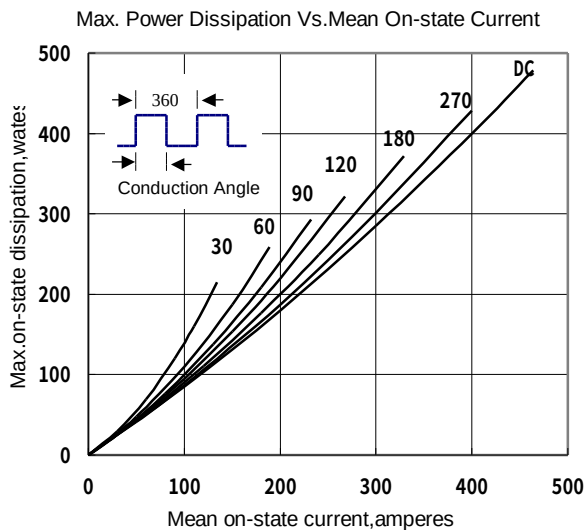


Fig.5

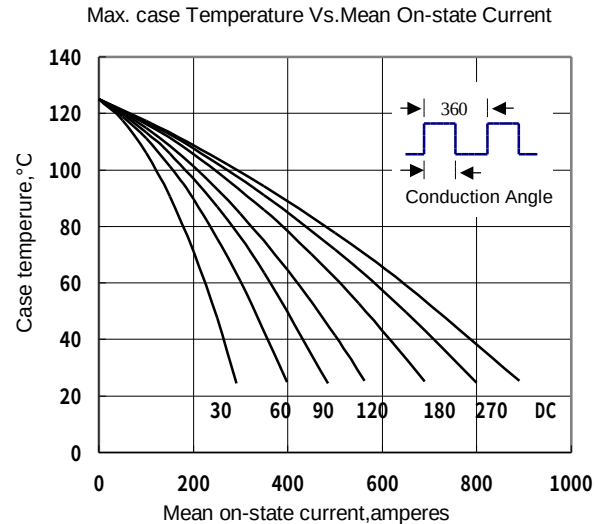


Fig.6

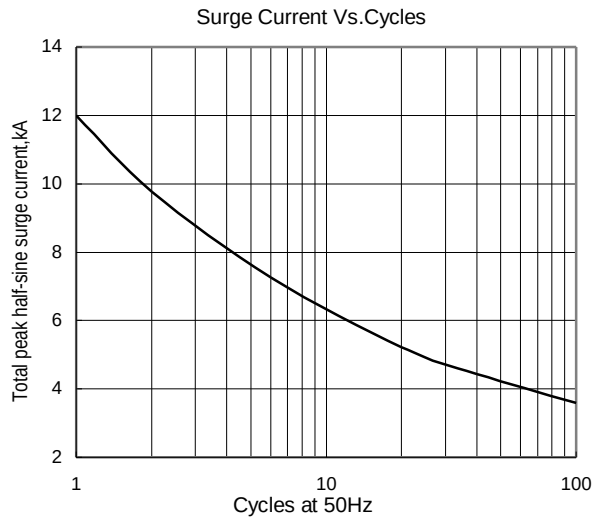


Fig.7

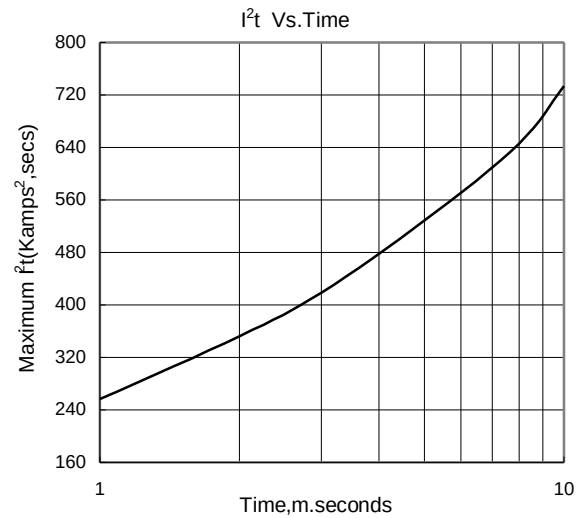


Fig.8

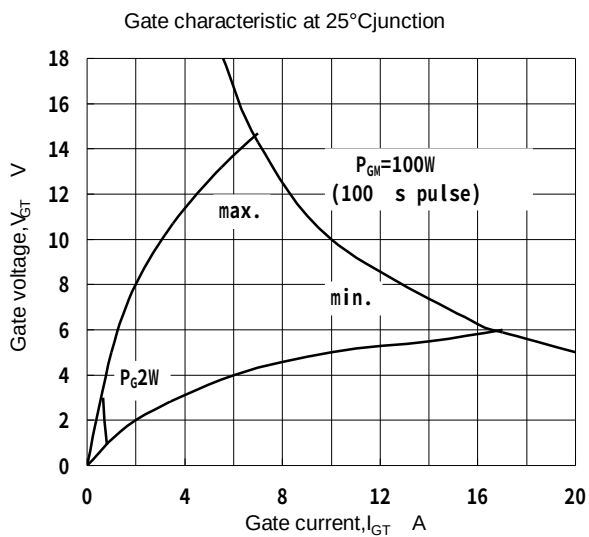


Fig.9

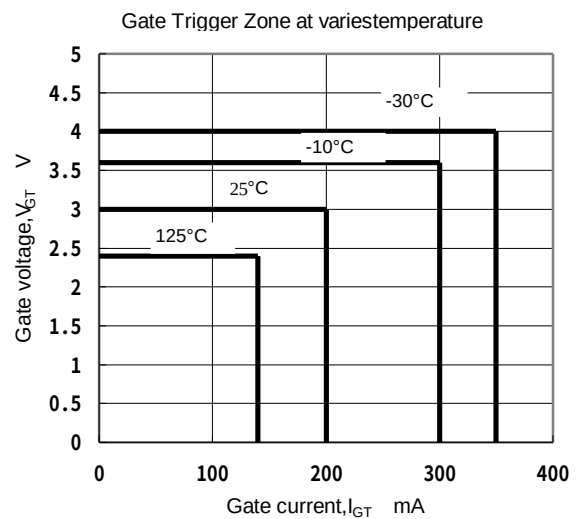


Fig.10